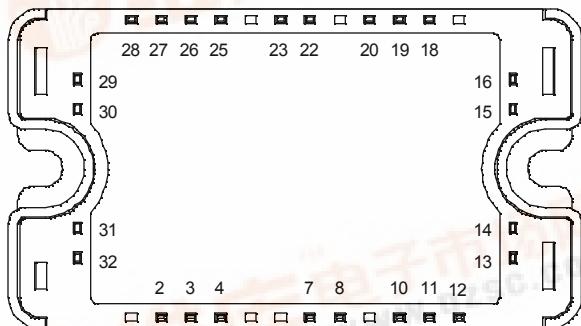
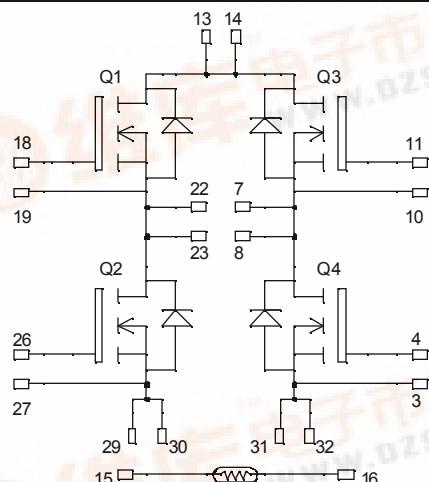




# APTM120H57FT3G

## Full - Bridge MOSFET Power Module

$V_{DSS} = 1200V$   
 $R_{DSon} = 570m\Omega$  typ @  $T_j = 25^\circ C$   
 $I_D = 17A$  @  $T_c = 25^\circ C$



All multiple inputs and outputs must be shorted together  
Example: 13/14 ; 29/30 ; 22/23 ...

### Absolute maximum ratings

Symbol      Parameter

Symbol	Parameter	Max ratings	Unit
$V_{DSS}$	Drain - Source Breakdown Voltage	1200	V
$I_D$	Continuous Drain Current	$T_c = 25^\circ C$	17
		$T_c = 80^\circ C$	13
$I_{DM}$	Pulsed Drain current	68	
$V_{GS}$	Gate - Source Voltage	$\pm 30$	V
$R_{DSon}$	Drain - Source ON Resistance	684	$m\Omega$
$P_D$	Maximum Power Dissipation	$T_c = 25^\circ C$	390
$I_{AR}$	Avalanche current (repetitive and non repetitive)	22	A
$E_{AR}$	Repetitive Avalanche Energy	50	
$E_{AS}$	Single Pulse Avalanche Energy	3000	$mJ$





# APTM120H57FT3G

All ratings @  $T_j = 25^\circ\text{C}$  unless otherwise specified

## Electrical Characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{GS} = 0\text{V}$ , $V_{DS} = 1200\text{V}$	$T_j = 25^\circ\text{C}$			250	$\mu\text{A}$
		$V_{GS} = 0\text{V}$ , $V_{DS} = 1000\text{V}$	$T_j = 125^\circ\text{C}$			1000	
$R_{DS(on)}$	Drain – Source on Resistance	$V_{GS} = 10\text{V}$ , $I_D = 8.5\text{A}$			570	684	$\text{m}\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 2.5\text{mA}$		3		5	$\text{V}$
$I_{GSS}$	Gate – Source Leakage Current	$V_{GS} = \pm 30\text{ V}$ , $V_{DS} = 0\text{V}$				$\pm 100$	$\text{nA}$

## Dynamic Characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
$C_{iss}$	Input Capacitance	$V_{GS} = 0\text{V}$ $V_{DS} = 25\text{V}$ $f = 1\text{MHz}$			5155		$\text{pF}$
$C_{oss}$	Output Capacitance				770		
$C_{rss}$	Reverse Transfer Capacitance				130		
$Q_g$	Total gate Charge	$V_{GS} = 10\text{V}$ $V_{Bus} = 600\text{V}$ $I_D = 17\text{A}$			187		$\text{nC}$
$Q_{gs}$	Gate – Source Charge				24		
$Q_{gd}$	Gate – Drain Charge				120		
$T_{d(on)}$	Turn-on Delay Time	<b>Inductive switching @ 125°C</b> $V_{GS} = 15\text{V}$ $V_{Bus} = 800\text{V}$ $I_D = 17\text{A}$			20		$\text{ns}$
$T_r$	Rise Time				15		
$T_{d(off)}$	Turn-off Delay Time				160		
$T_f$	Fall Time		$R_G = 5\Omega$		45		
$E_{on}$	Turn-on Switching Energy	<b>Inductive switching @ 25°C</b> $V_{GS} = 15\text{V}$ , $V_{Bus} = 800\text{V}$ $I_D = 17\text{A}$ , $R_G = 5\Omega$			990		$\mu\text{J}$
$E_{off}$	Turn-off Switching Energy				685		
$E_{on}$	Turn-on Switching Energy	<b>Inductive switching @ 125°C</b> $V_{GS} = 15\text{V}$ , $V_{Bus} = 800\text{V}$ $I_D = 17\text{A}$ , $R_G = 5\Omega$			1565		$\mu\text{J}$
$E_{off}$	Turn-off Switching Energy				857		

## Source - Drain diode ratings and characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
$I_S$	Continuous Source current (Body diode)		$T_c = 25^\circ\text{C}$			17	$\text{A}$
			$T_c = 80^\circ\text{C}$			13	
$V_{SD}$	Diode Forward Voltage	$V_{GS} = 0\text{V}$ , $I_S = - 17\text{A}$				1.3	$\text{V}$
$dv/dt$	Peak Diode Recovery ①					18	$\text{V/ns}$
$t_{rr}$	Reverse Recovery Time	$I_S = - 17\text{A}$ $V_R = 600\text{V}$ $dI/dt = 100\text{A}/\mu\text{s}$	$T_j = 25^\circ\text{C}$			320	$\text{ns}$
			$T_j = 125^\circ\text{C}$			650	
$Q_{rr}$	Reverse Recovery Charge		$T_j = 25^\circ\text{C}$		2		$\mu\text{C}$
			$T_j = 125^\circ\text{C}$		7		

①  $dv/dt$  numbers reflect the limitations of the circuit rather than the device itself.

$I_S \leq - 17\text{A}$     $di/dt \leq 700\text{A}/\mu\text{s}$     $V_R \leq V_{DSS}$     $T_j \leq 150^\circ\text{C}$



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### Thermal and package characteristics

Symbol	Characteristic		Min	Typ	Max	Unit
R <sub>thJC</sub>	Junction to Case Thermal Resistance			0.32		°C/W
V <sub>ISOL</sub>	RMS Isolation Voltage, any terminal to case t=1 min, I isol<1mA, 50/60Hz	2500				V
T <sub>J</sub>	Operating junction temperature range	-40		150		
T <sub>STG</sub>	Storage Temperature Range	-40		125		°C
T <sub>C</sub>	Operating Case Temperature	-40		100		
Torque	Mounting torque	To heatsink	M4	2.5	4.7	N.m
Wt	Package Weight			110		g

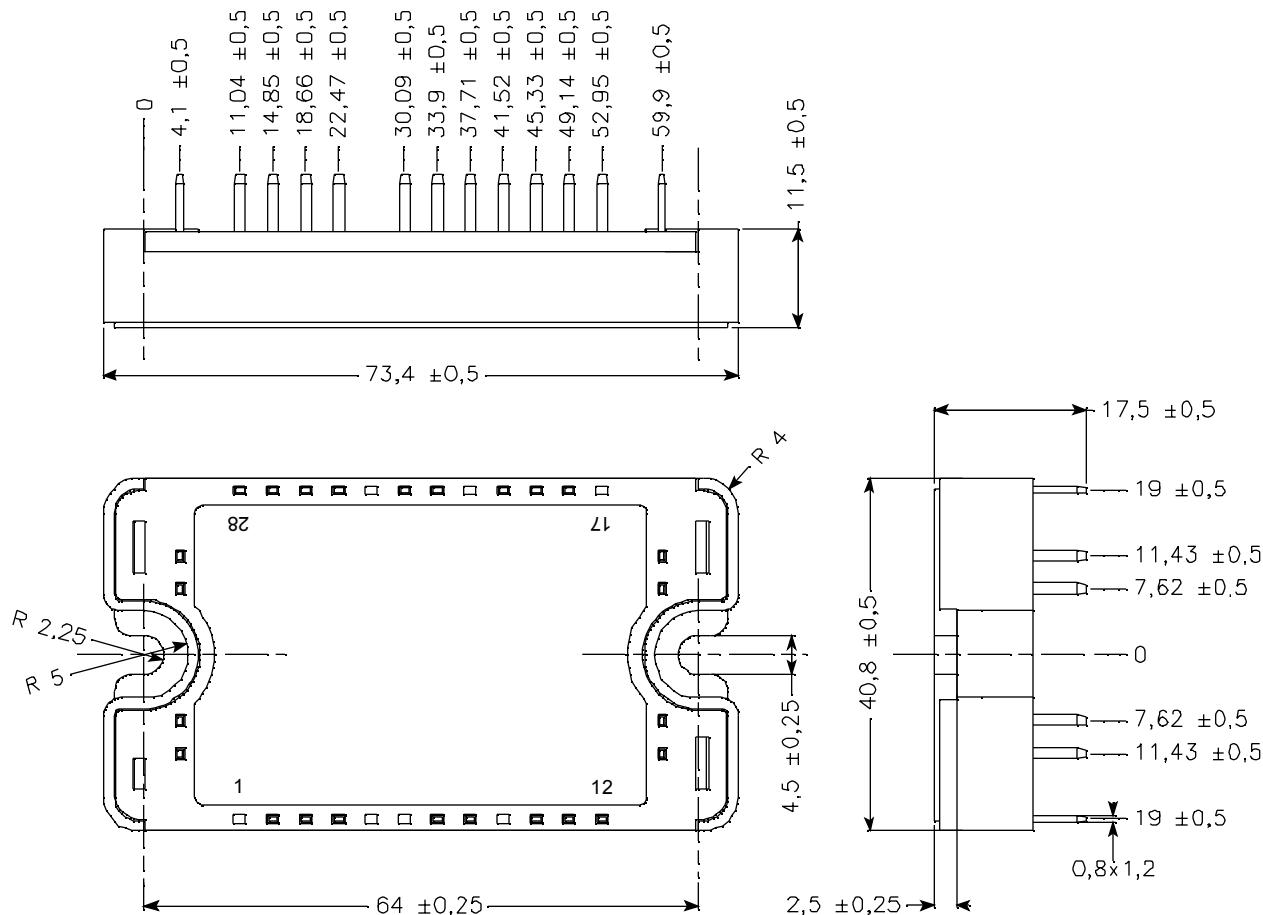
**Temperature sensor NTC** (see application note APT0406 on www.microsemi.com for more information).

Symbol	Characteristic		Min	Typ	Max	Unit
R <sub>25</sub>	Resistance @ 25°C			50		kΩ
B <sub>25/85</sub>	T <sub>25</sub> = 298.15 K		3952			K

$$R_T = \frac{R_{25}}{\exp\left[B_{25/85}\left(\frac{1}{T_{25}} - \frac{1}{T}\right)\right]}$$

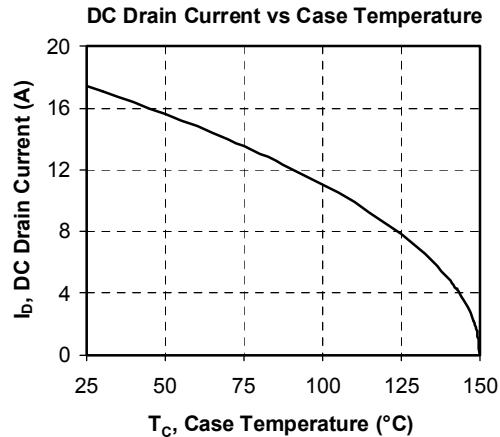
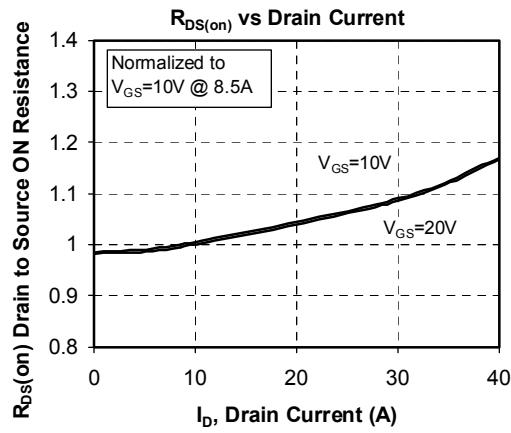
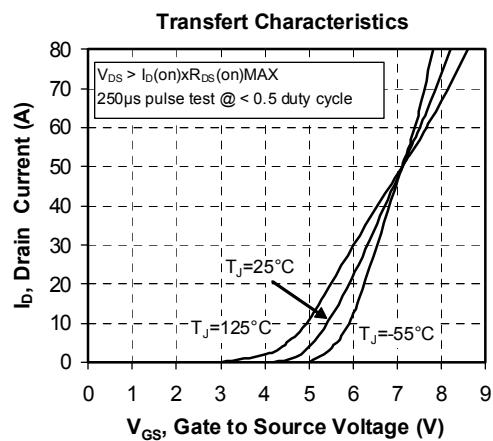
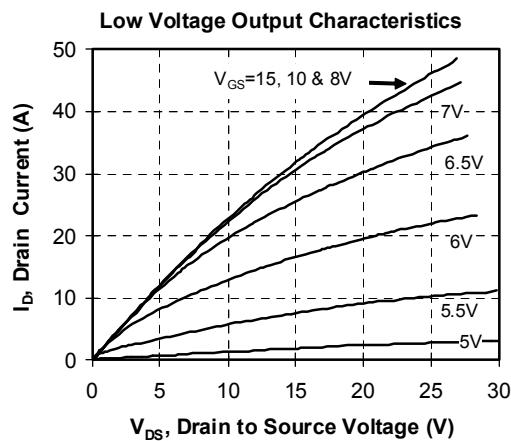
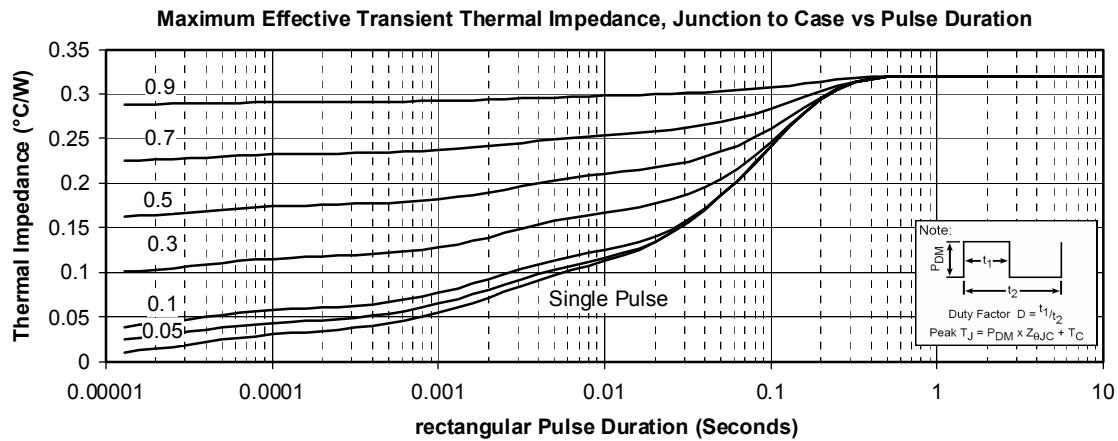
T: Thermistor temperature  
R<sub>T</sub>: Thermistor value at T

### SP3 Package outline (dimensions in mm)



See application note 1901 - Mounting Instructions for SP3 Power Modules on [www.microsemi.com](http://www.microsemi.com)

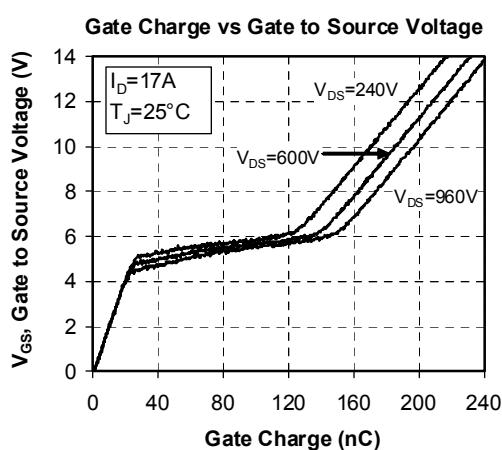
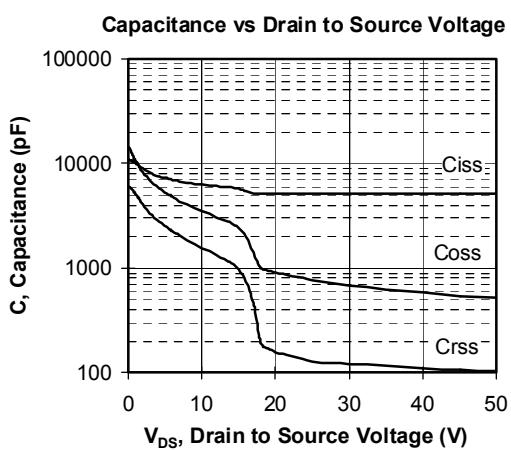
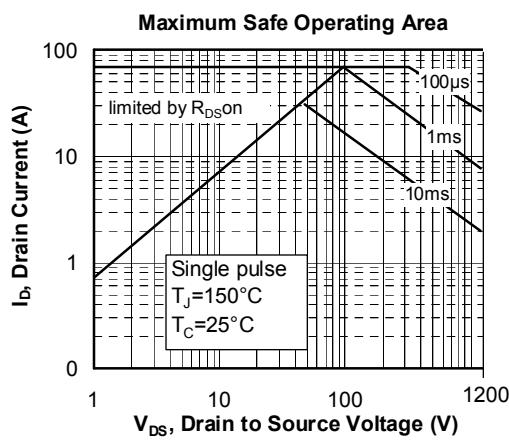
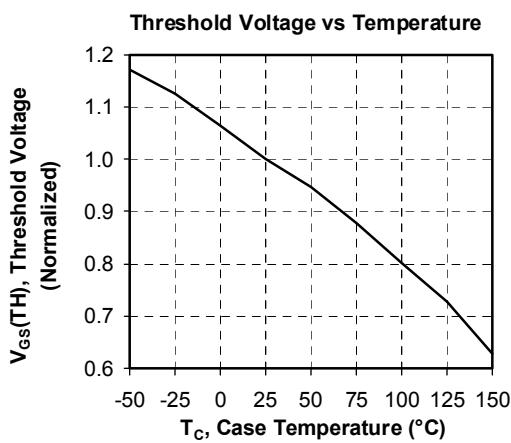
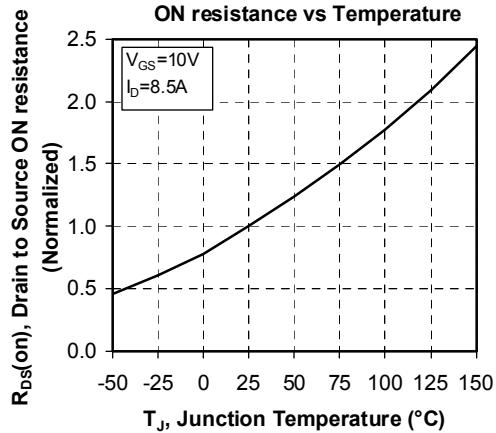
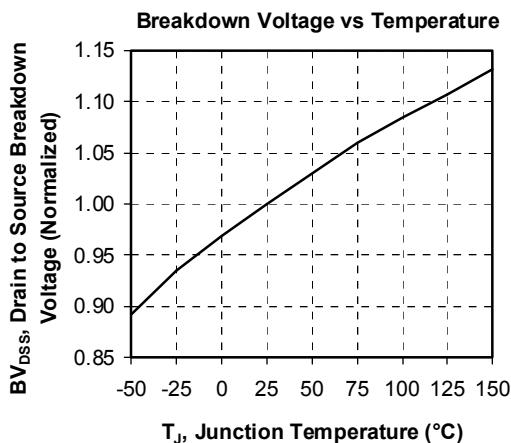
### Typical Performance Curve





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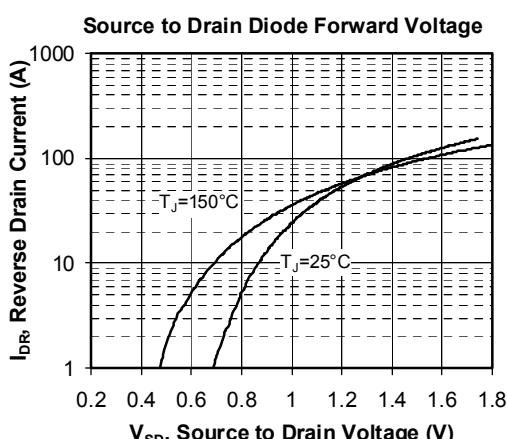
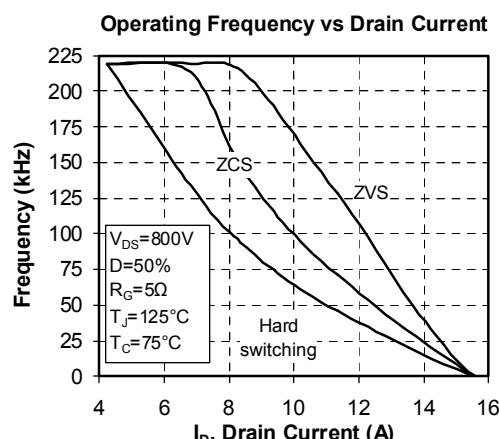
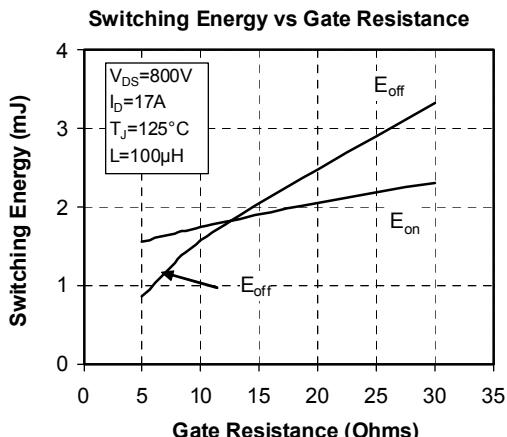
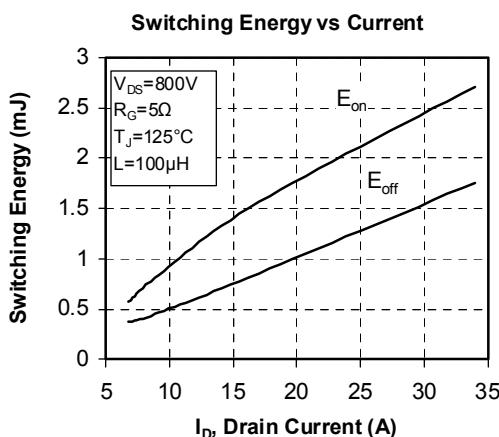
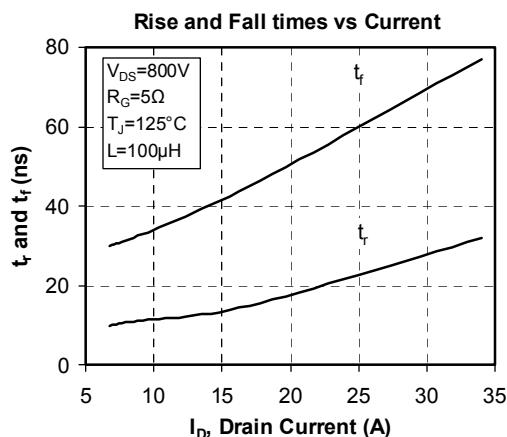
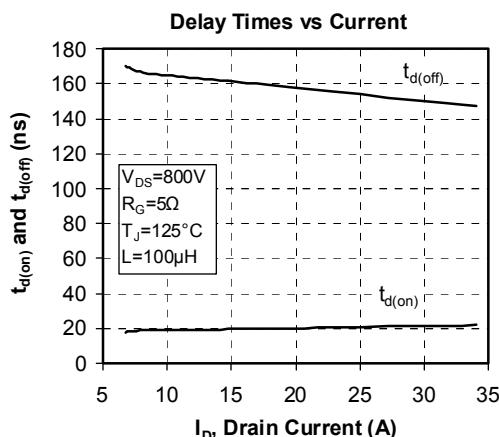
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Microsemi's products are covered by one or more of U.S. patents 4,895,810 5,045,903 5,089,434 5,182,234 5,019,522 5,262,336 6,503,786 5,256,583 4,748,103 5,283,202 5,231,474 5,434,095 5,528,058 and foreign patents pending. All Rights Reserved.